

Publishing Date	Material & Editorial Deadline	Features Vertical Focus Design	Exhibitions & Conferences 2019
January 14	January 2	Power Supplies & Batteries Biometrics & Data Encryption Sensors & Signal Conditioning	<b>MEMS 2019</b> , Seoul, Korea, January 27-31 <b>3D &amp; Systems Summit</b> , Dresden, January 28-30 <b>DesignCon</b> , Santa Clara, January 29-31
<b>February 18</b>	<b>February 6</b>	<b>Embedded supplement</b>	<b>Embedded World, Nuremberg, February 26-28</b>
February 18	February 6	AI & Machine Learning Programming tools & Dev Kits Circuit protection	<b>Wearable Technologies Conference 2019 EUROPE</b> , Munich, February 5-6 <b>Forum LED Europe</b> , Lyon, February 13-15 <b>Embedded World</b> , Nuremberg, February 26-28 <b>Mobile World Congress</b> , Barcelona, February 25-28
March 18	March 6	Automotive Electronics LED & OLED technologies Microwave & RF circuits	<b>EMV 2019</b> , Stuttgart, March 19-21 <b>LOPEC Printed Electronics</b> , Munich, March 19-21 <b>DATE 2019</b> , Florence, Italy, March 25-29 <b>Microwave &amp; RF- Paris Expo</b> , Paris March 20-21
April 8	March 27	Flexible Electronics Memory Technologies Edge computing	<b>Printed Electronics Europe</b> , Berlin, April 10-11 <b>Energy Harvesting &amp; Storage</b> , Berlin, April 10-11 <b>InnoRobo</b> , Lyon, April 10-11
May 6	April 24	Power Management Robotic advances Test & Measurement	<b>PCIM</b> , Nuremberg, May 7-9 <b>SMT</b> , Nuremberg, May 7-9 <b>Display Week</b> , San Jose, CA, May 12-17
June 10	May 29	Medical electronics & Biodevices Data Encryption & Security Sensors & Optoelectronics	<b>Design Automation Conference</b> , Las Vegas, June 2-6 <b>Transducers</b> , Berlin, June 23-27 <b>Sensor and Test</b> , Nuremberg, June 25-27
July 8	June 26	IC Design & EDA tools Displays Technologies Power Supplies & Batteries	
September 9	August 28	Circuit Interconnects Photovoltaics & Energy Harvesting Microcontrollers & Microprocessors	<b>35th European Photovoltaic Solar Energy Conf</b> , Brussels, Sept 29 – Oct 4
October 7	September 25	Digital Signal Processing & Accelerators Wireless Communications User interfaces	<b>European Microwave Week</b> , Paris, France, September 29- October 4
November 4	October 23	Electromobility advances Neuromorphic chips & systems Test & Measurement	<b>Semicon Europa 2019</b> , Munich, November 12-15 <b>Productronica 2019</b> , Munich, November 12-15 <b>SPS/IPC/Drives</b> , Nuremberg, November 26-28
December 2	November 20	3D Integration & Process Medical electronics & Biodevices LED & OLED advances	<b>Trustech 2019 (incorporates Cartes)</b> , Cannes, December

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